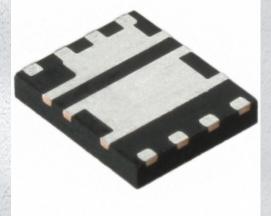


FDMS3610S Datasheet

www.digi-electronics.com



DiGi Electronics Part Number	
Manufacturer	

Manufacturer Product Number

and the second second

Description

Detailed Description

FDMS3610S-DG

onsemi

FDMS3610S

MOSFET 2N-CH 25V 17.5/30A PWR56

Mosfet Array 25V 17.5A, 30A 1W Surface Mount Pow er56

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Purchase and inquiry

Manufacturer Product Number:	Manufacturer:
FDMS3610S	onsemi
Series:	Product Status:
PowerTrench®	Obsolete
Technology:	Configuration:
MOSFET (Metal Oxide)	2 N-Channel (Dual) Asymmetrical
FET Feature:	Drain to Source Voltage (Vdss):
Logic Level Gate	25V
Current - Continuous Drain (ld) @ 25°C:	Rds On (Max) @ ld, Vgs:
17.5A, 30A	5mOhm @ 17.5A, 10V
Vgs(th) (Max) @ ld:	Gate Charge (Qg) (Max) @ Vgs:
2V @ 250µA	26nC @ 10V
Input Capacitance (Ciss) (Max) @ Vds:	Power - Max:
1570pF @ 13V	1W
Operating Temperature:	Mounting Type:
-55°C ~ 150°C (TJ)	Surface Mount
Package / Case:	Supplier Device Package:
8-PowerTDFN	Power56
Base Product Number:	
FDMS3610	

Environmental & Export classification

RoHS Status:	Moisture Sensitivity Level (MSL):
ROHS3 Compliant	1 (Unlimited)
REACH Status:	ECCN:
REACH Unaffected	EAR99
HTSUS:	
8541.29.0095	



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FDMS3610S PowerTrench[®] Power Stage 25V Asymmetric Dual N-Channel MOSFET

Features

Q1: N-Channel

- Max $r_{DS(on)} = 5.0 \text{ m}\Omega$ at $V_{GS} = 10 \text{ V}$, $I_D = 17.5 \text{ A}$
- Max $r_{DS(on)}$ = 5.7 m Ω at V_{GS} = 4.5 V, I_D = 16 A

Q2: N-Channel

- Max $r_{DS(on)}$ = 1.8 m Ω at V_{GS} = 10 V, I_D = 30 A
- Max $r_{DS(on)}$ = 2.2 m Ω at V_{GS} = 4.5 V, I_D = 27 A
- Low inductance packaging shortens rise/fall times, resulting in lower switching losses
- MOSFET integration enables optimum layout for lower circuit inductance and reduced switch node ringing
- RoHS Compliant

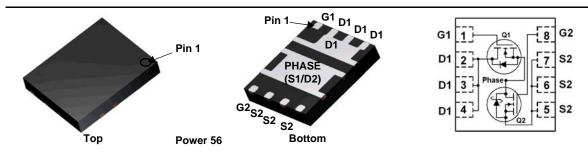


General Description

This device includes two specialized N-Channel MOSFETs in a dual PQFN package. The switch node has been internally connected to enable easy placement and routing of synchronous buck converters. The control MOSFET (Q1) and synchronous SyncFET (Q2) have been designed to provide optimal power efficiency.

Applications

- Computing
- Communications
- General Purpose Point of Load
- Notebook VCORE



MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Parameter		Q1	Q2	Units
V _{DS}	Drain to Source Voltage		25	25	V
V _{GS}	Gate to Source Voltage	(Note 4)	±12	±12	V
	Drain Current -Continuous (Package limited)	T _C = 25 °C	30	60	
I _D	-Continuous	T _A = 25 °C	17.5 ^{1a}	30 ^{1b}	А
	-Pulsed		70	120	
E _{AS}	Single Pulse Avalanche Energy	(Note 3)	29	86	mJ
Р	Power Dissipation for Single Operation	T _A = 25 °C	2.2 ^{1a}	2.5 ^{1b}	W
P _D	Power Dissipation for Single Operation	T _A = 25 °C	1.0 ^{1c}	1.0 ^{1d}	vv
T _J , T _{STG}	Operating and Storage Junction Temperature Range		-55 to	+150	°C

Thermal Characteristics

R_{\thetaJA}	Thermal Resistance, Junction to Ambient	57 ^{1a}	50 ^{1b}	
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	125 ^{1c}	120 ^{1d}	°C/W
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	3.0	2.2	

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
08OD 07OD	FDMS3610S	Power 56	13 "	12 mm	3000 units

December 2011

Symbol	Parameter	Test Conditions	Туре	Min	Тур	Max	Units
Off Char	acteristics						
BV _{DSS}	Drain to Source Breakdown Voltage	$I_D = 250 \ \mu A, \ V_{GS} = 0 \ V$ $I_D = 1 \ m A, \ V_{GS} = 0 \ V$	Q1 Q2	25 25			V
ΔΒV _{DSS} ΔΤ _J	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C $I_D = 10 \ m$ A, referenced to 25 °C	Q1 Q2		12 24		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 20 V, V _{GS} = 0 V	Q1 Q2			1 500	μΑ μΑ
I _{GSS}	Gate to Source Leakage Current	V_{GS} = 12 V/-8 V, V_{DS} = 0 V	Q1 Q2			±100 ±100	nA nA
On Char	acteristics						
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \ \mu A$ $V_{GS} = V_{DS}, I_D = 1 \ m A$	Q1 Q2	0.8 1.1	1.2 1.4	2.0 2.2	V
$rac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C $I_D = 10 \ m$ A, referenced to 25 °C	Q1 Q2		-4 -3		mV/°C
	Drain to Source On Resistance	$ \begin{array}{c} V_{GS} = 10 \text{ V}, \ I_D = 17.5 \text{ A} \\ V_{GS} = 4.5 \text{ V}, \ I_D = 16 \text{ A} \\ V_{GS} = 10 \text{ V}, \ I_D = 17.5 \text{ A}, T_J = 125 \ ^\circ\text{C} \end{array} $	Q1		3.8 4.4 5.4	5.0 5.7 7.0	- mΩ
r					1.5	1.8	1115.2
r DS(on)	Drain to Source On Resistance		Q2		1.8 2.1	2.2 2.7	

C _{iss}	Input Capacitance	Q1: V _{DS} = 13 V, V _{GS} = 0 V, f = 1 MHZ	Q1 Q2	1570 4045	pF
C _{oss}	Output Capacitance	Q2:	Q1 Q2	448 946	pF
C _{rss}	Reverse Transfer Capacitance	V _{DS} = 13 V, V _{GS} = 0 V, f = 1 MHZ	Q1 Q2	61 117	pF
Rg	Gate Resistance		Q1 Q2	0.4 0.9	Ω

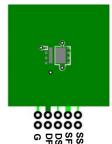
Switching Characteristics

t _{d(on)}	Turn-On Delay Time	_		Q1 Q2	7 11	ns
t _r	Rise Time	Q1: V _{DD} = 13 V, I _D = 17	.5 A, R _{GEN} = 6 Ω	Q1 Q2	2 5	ns
t _{d(off)}	Turn-Off Delay Time	Q2: V _{DD} = 13 V, I _D = 30	$A = R_{0} = 6.0$	Q1 Q2	23 39	ns
t _f	Fall Time		, NGEN - 0 32	Q1 Q2	2 4	ns
Qg	Total Gate Charge	$V_{GS} = 0$ V to 10 V		Q1 Q2	26 59	nC
Qg	Total Gate Charge	$V_{GS} = 0$ V to 4.5 V	V _{DD} = 13 V, I _D = 17.5 A	Q1 Q2	12 27	nC
Q _{gs}	Gate to Source Gate Charge		Q2 V _{DD} = 13 V,	Q1 Q2	3.3 8.2	nC
Q _{gd}	Gate to Drain "Miller" Charge		$I_{\rm D} = 30 {\rm A}$	Q1 Q2	2.7 7.6	nC

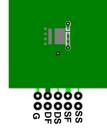
Symbol	Parameter	Test Conditions	Туре	Min	Тур	Max	Units
Drain-So	urce Diode Characteristics						
V	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 17.5 A$ (Note 2)	Q1		0.8	1.2	V
V _{SD}	Source to Drain Diode Forward Voltage		Q2		0.8	1.2	V
		Q1	Q1		23		
t _{rr}	Reverse Recovery Time	I _F = 17.5 A, di/dt = 100 A/μs	Q2		28		ns
<u>^</u>	David David Olaria	Q2	Q1		9		
Q _{rr}	Reverse Recovery Charge	I _F = 30 A, di/dt = 300 A/μs	Q2		28	1	nC

Notes:

1.R_{8JA} is determined with the device mounted on a 1 in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R_{8JC} is guaranteed by design while R_{8CA} is determined by the user's board design.



a. 57 °C/W when mounted on a 1 in² pad of 2 oz copper



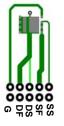
b. 50 °C/W when mounted on a 1 in² pad of 2 oz copper

2 Pulse Test: Pulse Width < 300 μ s, Duty cycle < 2.0%.

c. 125 °C/W when mounted on a minimum pad of 2 oz copper

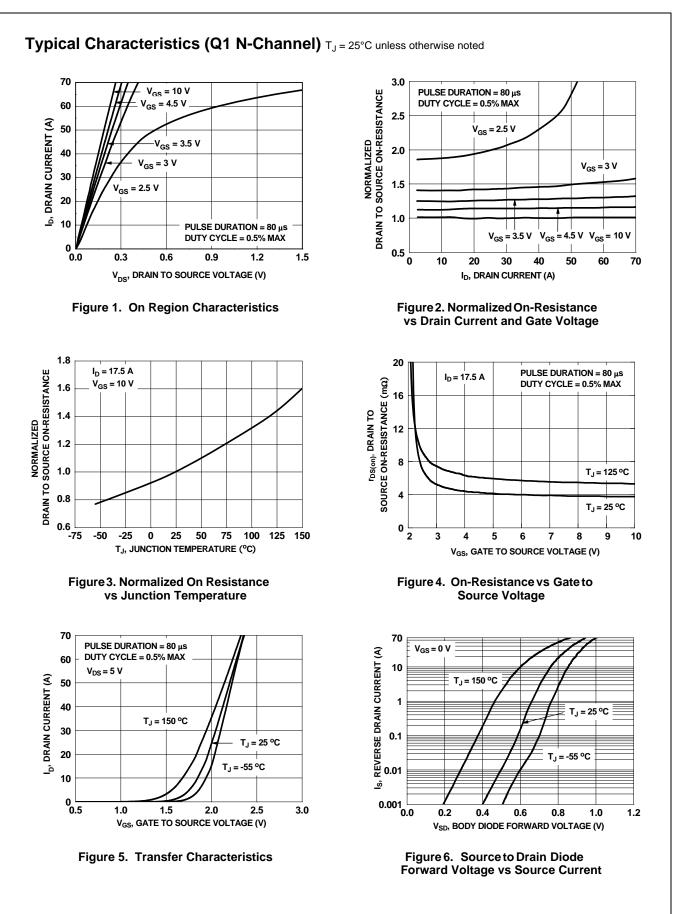
3. Q1 : E_{AS} of 29 mJ is based on starting T_J = 25 o C; N-ch: L = 1.2 mH, I_{AS} = 7 A, V_{DD} = 23 V, V_{GS} = 10 V. 100% test at L = 0.1 mH, I_{AS} = 16 A. Q2: E_{AS} of 86 mJ is based on starting T_J = 25 o C; N-ch: L = 0.6 mH, I_{AS} = 17 A, V_{DD} = 23 V, V_{GS} = 10 V. 100% test at L = 0.1 mH, I_{AS} = 31 A.

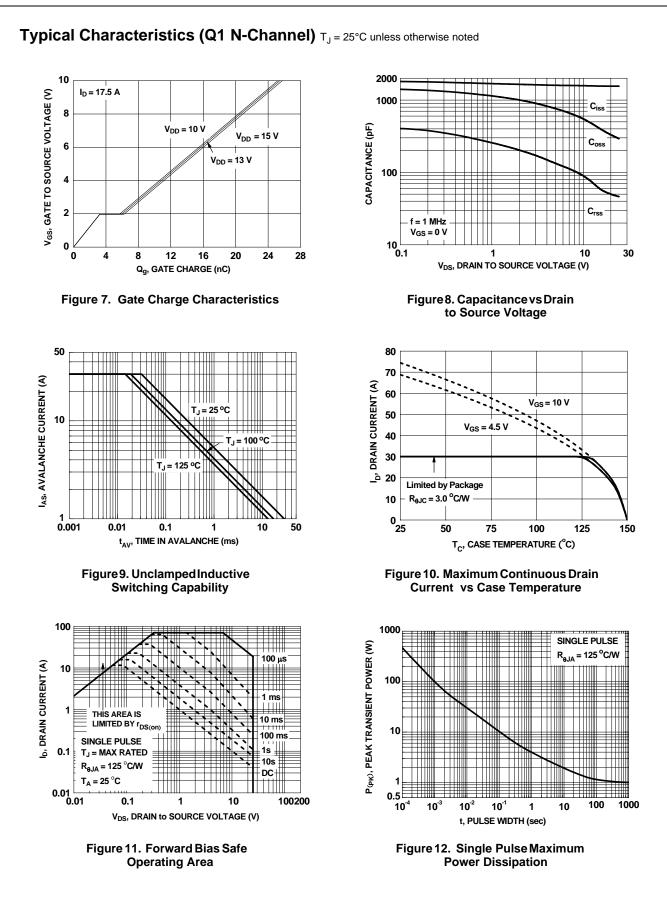
4. As an N-ch device, the negative Vgs rating is for low duty cycle pulse occurrence only. No continuous rating is implied.

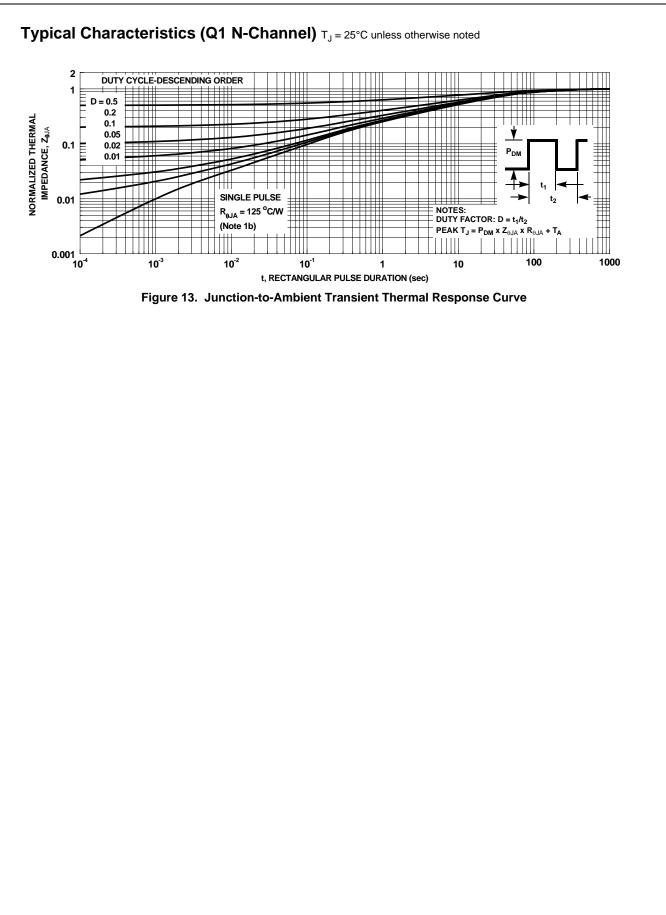


d. 120 °C/W when mounted on a minimum pad of 2 oz copper

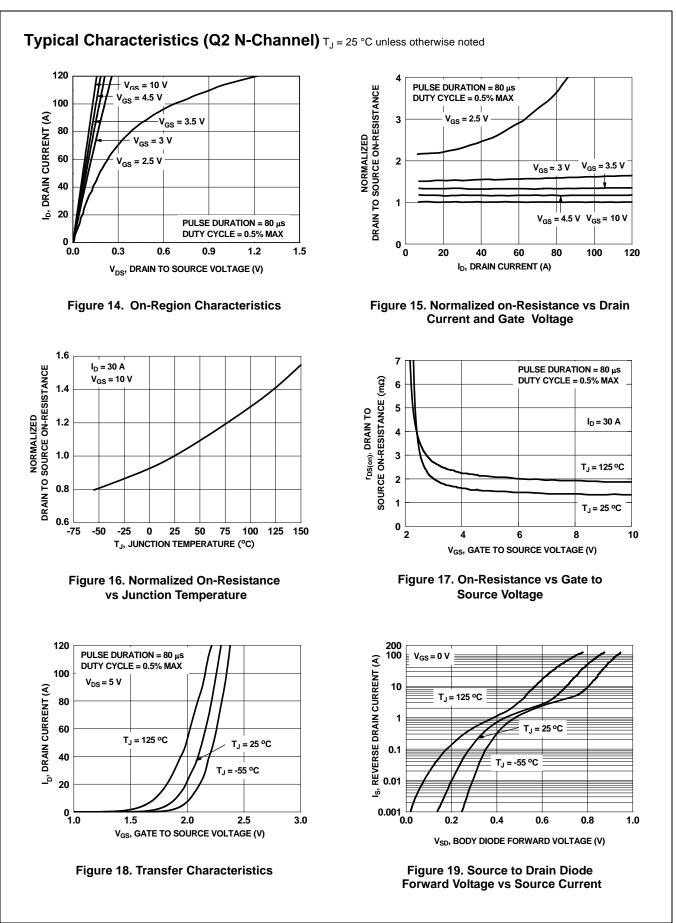




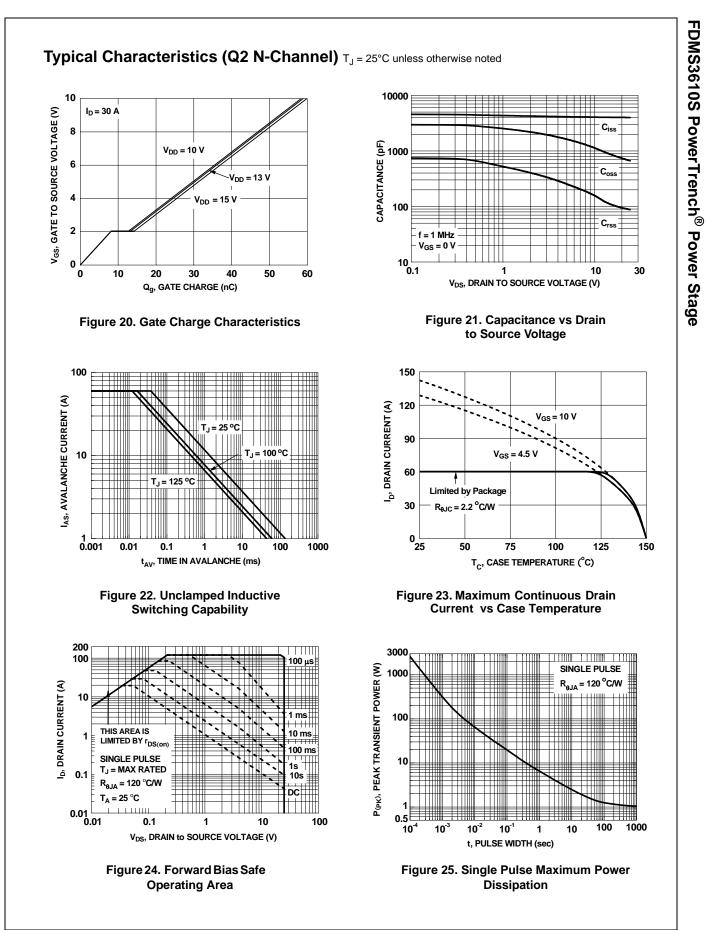


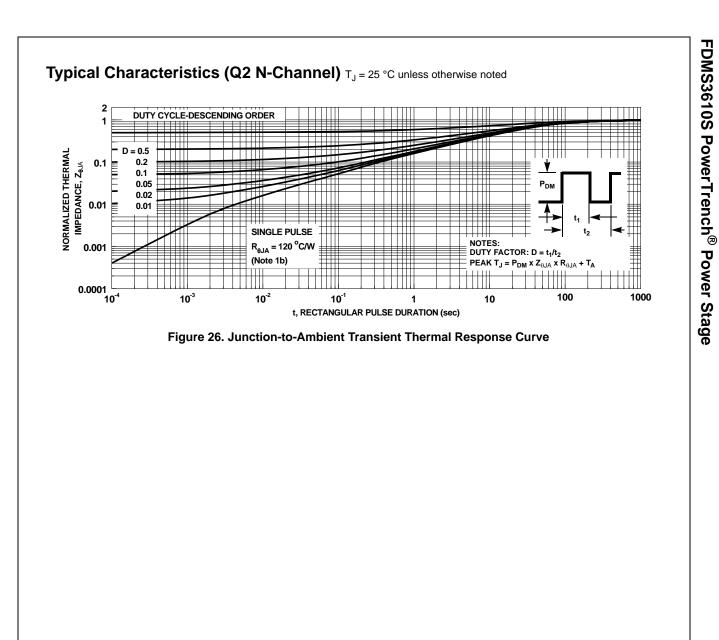


FDMS3610S PowerTrench[®] Power Stage



FDMS3610S PowerTrench[®] Power Stage





Typical Characteristics (continued)

SyncFET Schottky body diode Characteristics

Fairchild's SyncFET process embeds a Schottky diode in parallel with PowerTrench MOSFET. This diode exhibits similar characteristics to a discrete external Schottky diode in parallel with a MOSFET. Figure 27 shows the reverse recovery characteristic of the FDMS3610S.

 $\begin{array}{c} 35 \\ 30 \\ 25 \\ 20 \\ 15 \\ 10 \\ 5 \\ 0 \\ -5 \\ 0 \\ 40 \\ 80 \\ 120 \\ 160 \\ 200 \\ 240 \\ 280 \\ 320 \\ 360 \\ TIME (ns) \end{array}$

Figure 27. FDMS3610S SyncFET body diode reverse recovery characteristic

Schottky barrier diodes exhibit significant leakage at high temperature and high reverse voltage. This will increase the power in the device.

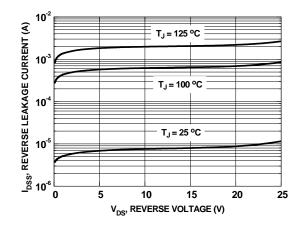
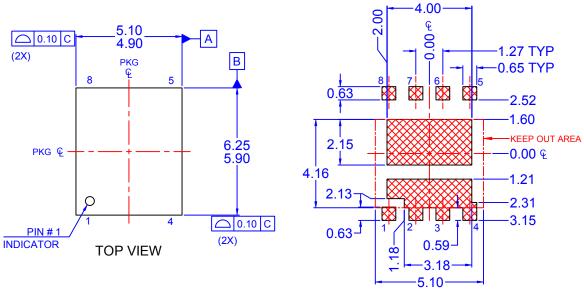
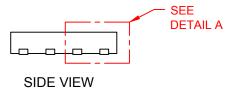
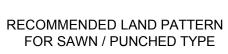
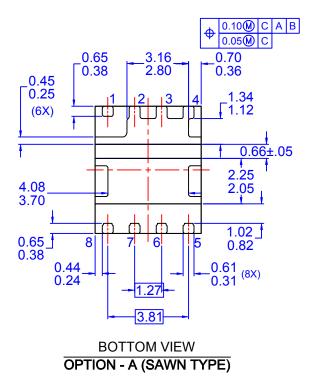


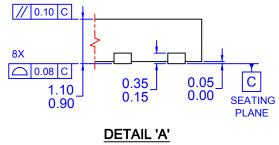
Figure 28. SyncFET body diode reverse leakage versus drain-source voltage



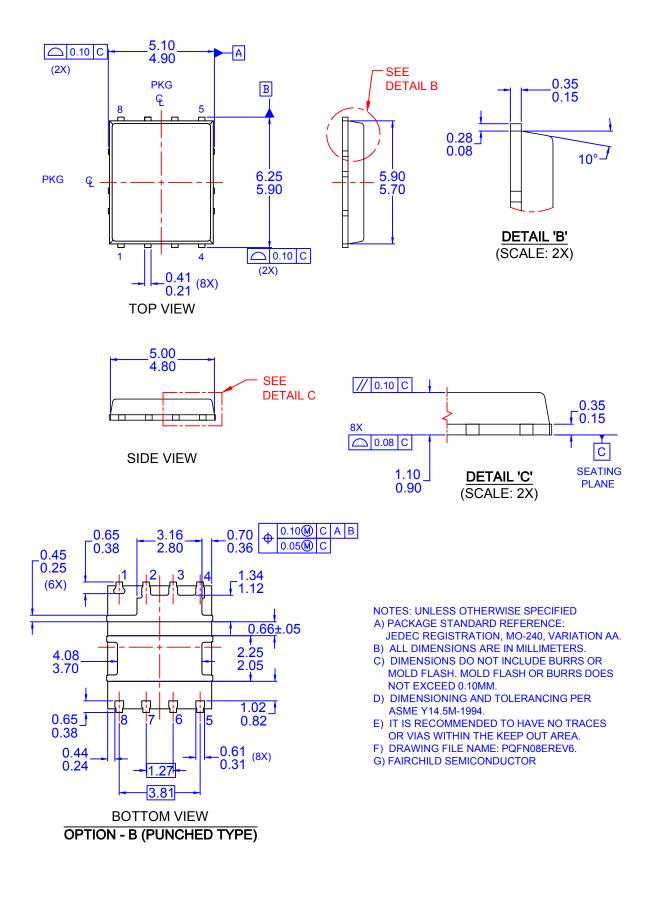








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FDMS3610S onsemi MOSFET 2N-CH 25V 17.5/30A PWR56

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